

UTC UNISONIC TECHNOLOGIES CO., LTD

1N70-CB

Preliminary

1.0A, 700V N-CHANNEL **POWER MOSFET**

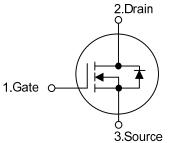
DESCRIPTION

The UTC 1N70-CB is a high voltage MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

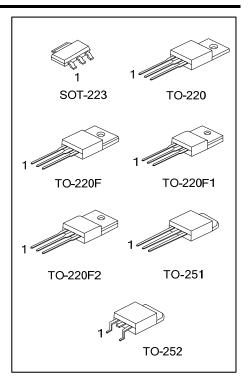
FEATURES

- * $R_{DS(ON)}$ < 12 Ω @ V_{GS} = 10V , I_D = 0.5A
- * Fast switching capability
- * Avalanche energy specified
- * Improved dv/dt capability, high ruggedness

SYMBOL

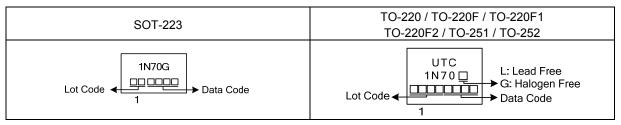


ó 3.Source							
ORDERING INFO	RMATION						
Ordering Number		Package	Pin	Assignm	Packing		
Lead Free	Halogen Free	Fackage	1	2	3	Facking	
-	1N70G-AA3-R	SOT-223	G	D	S	Tape Reel	
1N70L-TA3-T	1N70G-TA3-T	TO-220	G	D	S	Tube	
1N70L-TF1-T	1N70G-TF1-T	TO-220F1	G	D	S	Tube	
1N70L-TF2-T	1N70G-TF2-T	TO-220F2	G	D	S	Tube	
1N70L-TF3-T	1N70G-TF3-T	TO-220F	G	D	S	Tube	
1N70L-TM3-T	1N70G-TM3-T	TO-251	G	D	S	Tube	
1N70L-TN3-R	1N70G-TN3-R	TO-252	G	D	S	Tape Reel	
Note: Pin Assignment: G:	Gate D: Drain S: Source	9		$\sim 2^{1}$	-		
1N70G-AA3-R		(1) T: Tube, F	R• Tape B	eel O	(1.		
(1) Packing Type (2) AA3: SOT-223, TA3: TO-220, TF3: TO-220F,					0-220F,		
(2)Package Type TF1: TO-220F1, TF2: TO-220F2, TM3: TO-251, TN3: TO-252					3: TO-251,		
(3)Green Package (3)L: Lead Free, G: Halogen Free and Lead Free					ead Free		
(3) L. Leau Free, G. Halogen Free and Leau Free							
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1N70-CB

MARKING





ABSOLUTE MAXIMUM RATINGS (T_c = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V _{DSS}	700	V
Gate-Source Voltage		V _{GSS}	±30	V
Drain Current	Continuous	I _D	1.0	А
	Pulsed (Note 2)	I _{DM}	4.0	А
Avalanche Current (Note 2)		I _{AR}	1.5	А
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	11	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.6	V/ns
Power Dissipation	SOT-223		9	W
	TO-220		40	W
	TO-220F/TO-220F1 TO-220F2	P _D	21	W
	TO-251/TO-252		28	W
Junction Temperature		TJ	+150	°C
Storage Temperature		T _{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

- 3. L=10mH, I_{AS}=1.5A, V_{DD}=50V, R_G=25 Ω , Starting T_J = 25°C
- 4. I_{SD} \leq 1.0A, di/dt \leq 200A/µs, V_{DD} \leq BV_{DSS}, Starting T_J = 25°C

THERMAL DATA

PARAMETER		SYMBOL	RATING	UNIT	
Junction to Ambient	SOT-223		150	°C/W	
	TO-220/TO-220F TO-220F1/TO-220F2	θ_{JA}	62.5	°C/W	
	TO-251/TO-252		110	°C/W	
Junction to Case	SOT-223		14	°C/W	
	TO-220		3.13	°C/W	
	TO-220F/TO-220F1 TO-220F2	θ_{JC}	5.95	°C/W	
	TO-251/TO-252		4.46	°C/W	



■ ELECTRICAL CHARACTERISTICS (T_J = 25°C, unless otherwise specified)

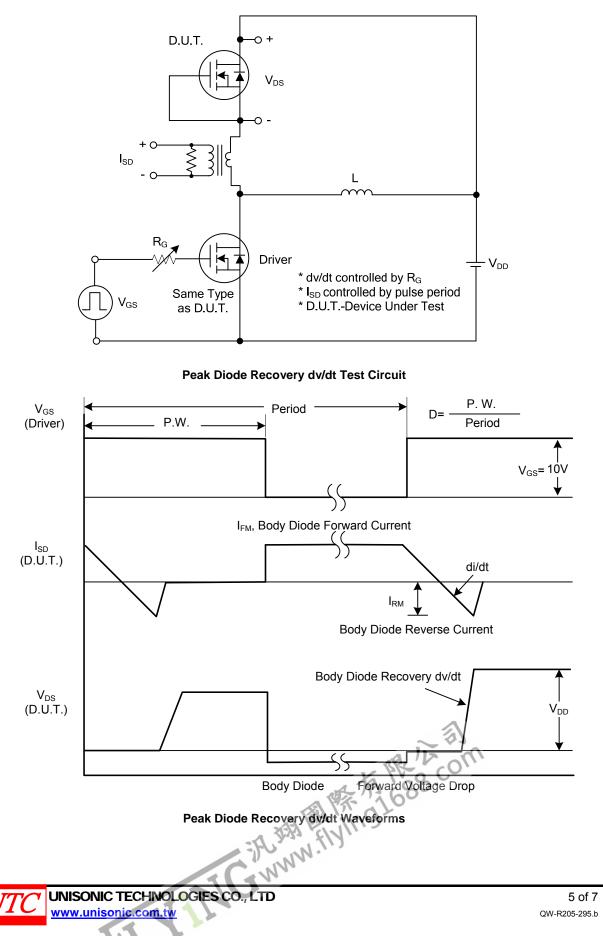
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS				1			
Drain-Source Breakdown Voltage		BV _{DSS}	V _{GS} = 0V, I _D = 250µA	700			V
Drain-Source Leakage Current		I _{DSS}	$V_{DS} = 700V, V_{GS} = 0V$			1	μA
Gate-Source Leakage Current	Forward	- I _{GSS}	V _{GS} = 30V, V _{DS} = 0V			100	nA
	Reverse		$V_{GS} = -30V, V_{DS} = 0V$			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		V _{GS(TH)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4.0	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} = 10V, I _D =0.5A			12	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance	Input Capacitance				195		рF
Output Capacitance		C _{OSS}	V_{DS} =25V, V_{GS} =0V, f =1MHz		29		рF
Reverse Transfer Capacitance		C _{RSS}			15		рF
SWITCHING CHARACTERISTIC	S						
Total Gate Charge (Note 1)		Q_{G}	V _{DS} =50V, V _{GS} =10V, I _D =0.83A		18		nC
Gate to Source Charge		Q_{GS}	$I_{G}=100\mu A$ (Note 1, 2)		1.7		nC
Gate to Drain Charge		Q_{GD}			1.7		nC
Turn-ON Delay Time (Note 1)		t _{D (ON)}			36		ns
Rise Time		t _R	V _{DS} =30V, V _{GS} =10V, I _D =0.5A,		14		ns
Turn-OFF Delay Time		t _{D(OFF)}	R _G =25Ω (Note 1, 2)		78		ns
Fall-Time		t _F			12		ns
SOURCE- DRAIN DIODE RATIN	GS AND CH	ARACTERIS	TICS				
Maximum Body-Diode Continuous Current		I _{SD}				1.0	Α
Maximum Body-Diode Pulsed Current		I _{SM}				4.0	А
Drain-Source Diode Forward Voltage (Note 1)		V_{SD}	I _S =1.0A, V _{GS} =0V			1.4	V
Body Diode Reverse Recovery Time (Note 1)		t _{rr}	I _S =1.0A, V _{GS} =0V,		250		nS
Body Diode Reverse Recovery Charge		Qrr	dI _F /dt=100A/µs		0.43		μC

Notes: 1. Pulse Test: Pulse width \leq 300µs, Duty cycle \leq 2%.

2. Essentially independent of operating temperature.



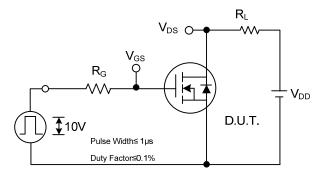
TEST CIRCUITS AND WAVEFORMS

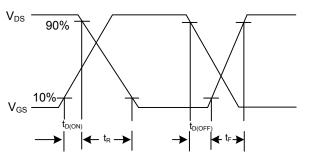


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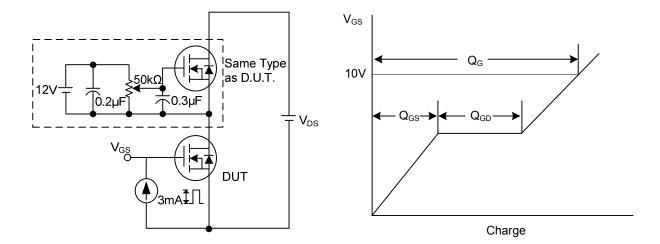
TEST CIRCUITS AND WAVEFORMS (Cont.)





Switching Test Circuit

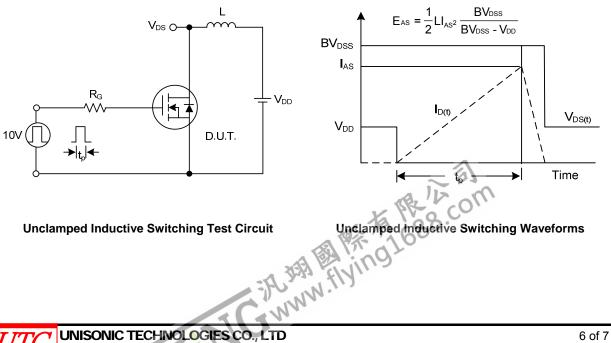
Switching Waveforms



Gate Charge Test Circuit

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Gate Charge Waveform



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